# **JP** \$40.00 1178

### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Won-Hoe KOO	01/26/2007
Hoon KIM	01/26/2007
Jung-Mi CHOI	01/26/2007

### **RECEIVING PARTY DATA**

Name:	Samsung Electronics Co., Ltd.	
Street Address:	416 Maetan-dong, Yeongtong-gu, Gyeonggi-do	
City:	Suwon-si	
State/Country:	KOREA, REPUBLIC OF	

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11753259

## **CORRESPONDENCE DATA**

Fax Number: (703)288-5139

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 703-288-5105

Email: patent@park-law.com

Correspondent Name: H.C. Park & Associates, PLC
Address Line 1: 8500 Leesburg Pike, Suite 7500

Address Line 4: Vienna, VIRGINIA 22182

P2023US00

NAME OF SUBMITTER: Hae-Chan Park

Total Attachments: 2

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PATENT REEL: 019403 FRAME: 0131



PROFESSION CONTRACTOR OF THE PROPERTY

Attorney's Docket No.: P2023US00

### **ASSIGNMENT**

416 Maetan-dong, Yeongtong-gu Suwon-si Gyeonggi-do South Korea

Samsung Electronics Co., Ltd. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.

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,然即1996年1月1日 - 1997年1月1日 - 1998年1

**RECORDED: 06/08/2007** 

# IN WITNESS WHEREOF, Assignor has hereunto set hand and seal.

First Inventor's Name:	Won-Hoe KOO
Address:	Hwanggol Maeul 1-danji Apt. #133-1302 Yeongtong-dong, Yeongtong-gu, Gyeonggi-do Suwon-si South Korea
First Inventor's Signature:	JANUARY 26, 2007
Date:	JANUARY 26, 2007
Second Inventor's Name:	Hoon KIM
Address:	Sinyeongtong Hyundai 4-cha., Apt. #404-202, Banwol-ri Taean-eup, Hwaseong-si, Gyeonggi-do South Korea
Second Inventor's Signature:	Down Kin
Date:	JANUARY 26, 2007
Third Inventor's Name:	Jung-Mi CHOI
Address:	Jiyedang Jindalraedong #429, San 24 Nongseo-ri, Giheung-eup, Gyeonggi-do Yongin-si South Korea
Third Inventors' Signature:	Chai jung mi
Date:	JANUARY 26, 2007